

**ON Semiconductor®** FDD9410-F085

# N-Channel Power Trench<sup>®</sup> MOSFET

## **40 V, 50 A, 4.1 m**Ω

#### Features

- Typ r<sub>DS(on)</sub> = 3.5 mΩ at V<sub>GS</sub> = 10V, I<sub>D</sub> = 50 A
- Typ Q<sub>g(tot)</sub> = 23.5 nC at V<sub>GS</sub> = 10V, I<sub>D</sub> = 50 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

#### Applications

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Integrated Starter/alternator
- Primary Switch for 12V Systems

#### MOSFET Maximum Ratings T<sub>J</sub> = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V <sub>DSS</sub>	Drain to Source Voltage		40	V
V <sub>GS</sub>	Gate to Source Voltage		±20	V
I <sub>D</sub>	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	T <sub>C</sub> =25°C	50	^
	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure4	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	40	mJ
P <sub>D</sub>	Power Dissipation		75	W
	Derate Above 25°C		0.5	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 175	°C
$R_{\theta JC}$	Thermal Resistance Junction to Case		2	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance Junction to Ambient	(Note 3)	52	°C/W

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD9410	FDD9410-F085	D-PAK(TO-252)	13"	12mm	2500 units

Notes:

1: Current is limited by bondwire configuration.

2: Starting  $T_J = 25^{\circ}C$ , L = 50uH,  $I_{AS} = 40A$ ,  $V_{DD} = 40V$  during inductor charging and  $V_{DD} = 0V$  during time in avalanche. 3:  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder <sup>407</sup> mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta JA}$  is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.



G

D

D-PAK (TO-252)

Symbol	Parameter	Test Conditions		Min	Тур	Мах	Units	
Off Cha	racteristics							
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V		40	-	-	V	
1	Drain to Source Leakage Current	V <sub>DS</sub> = 40V,	T <sub>J</sub> =	25°C	-	-	1	μA
DSS		$V_{GS} = 0V$	T <sub>J</sub> =	175ºC(Note 4)	-	-	1	mA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V$			-	-	±100	nA
r <sub>DS(on)</sub>	Drain to Source On Resistance	$I_{\rm D} = 50A$ ,	ון = ד		-	3.5	4.1	mΩ
. ,		V <sub>GS</sub> = 10V	= ا <sub>ا</sub>	175ºC(Note 4)	-	6.1	7.1	mΩ
Jynami	c Characteristics							
C <sub>iss</sub>	Input Capacitance	1/25/(-)	/ C		-	1715	-	pF
C <sub>oss</sub>	Output Capacitance	— V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1MHz		-	453	-	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			-	28	-	pF	
R <sub>g</sub>	Gate Resistance	f = 1MHz		-	2.3	-	Ω	
Q <sub>g(ToT)</sub>	Total Gate Charge at 10V	$V_{GS} = 0$ to 10		V <sub>DD</sub> = 20V	-	23.5	34.5	nC
Q <sub>g(th)</sub>	Threshold Gate Charge	$V_{GS} = 0$ to 2	/	I <sub>D</sub> = 50A	-	3.2	4	nC
Q <sub>gs</sub>	Gate to Source Gate Charge				-	9.6	-	nC
$\cap$	Cata to Drain "Millor" Chargo					11		nC

## **Switching Characteristics**

Gate to Drain "Miller" Charge

t <sub>on</sub>	Turn-On Time		-	-	38	ns
t <sub>d(on)</sub>	Turn-On Delay Time		-	12	-	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 20V, I <sub>D</sub> = 50A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω	-	12	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω	-	20	-	ns
t <sub>f</sub>	Fall Time		-	9	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	45	ns

-

4.4

-

nC

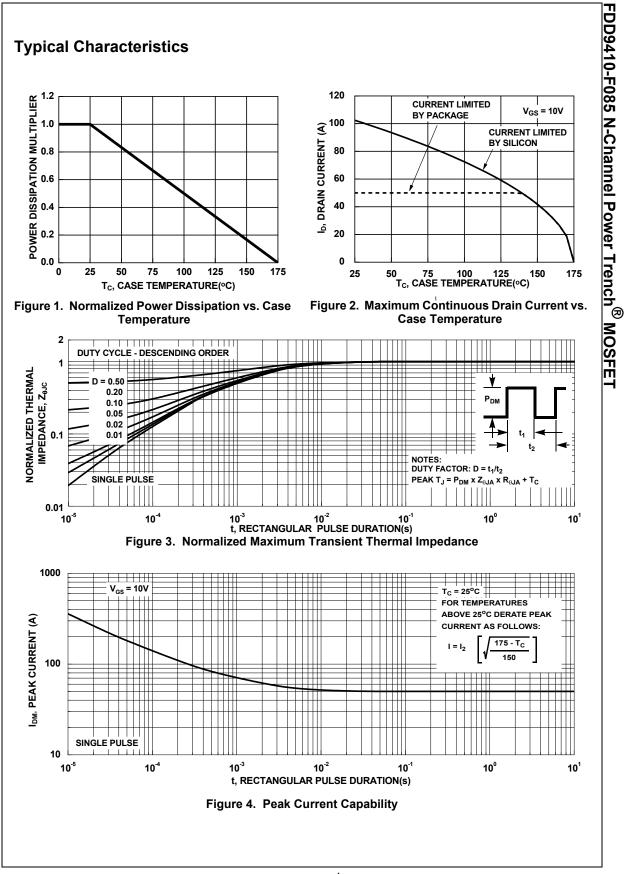
### **Drain-Source Diode Characteristics**

\/	Source to Drain Diode Voltage	I <sub>SD</sub> = 50A, V <sub>GS</sub> = 0V	-	-	1.25	V
V <sub>SD</sub>	Source to Drain Diode Voltage	$I_{SD}$ = 25A, $V_{GS}$ = 0V	-	-	1.2	V
T <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 50A, dI <sub>SD</sub> /dt = 100A/μs,	-	44	58	ns
Q <sub>rr</sub>	Reverse Recovery Charge	V <sub>DD</sub> =32V	-	31.5	41	nC

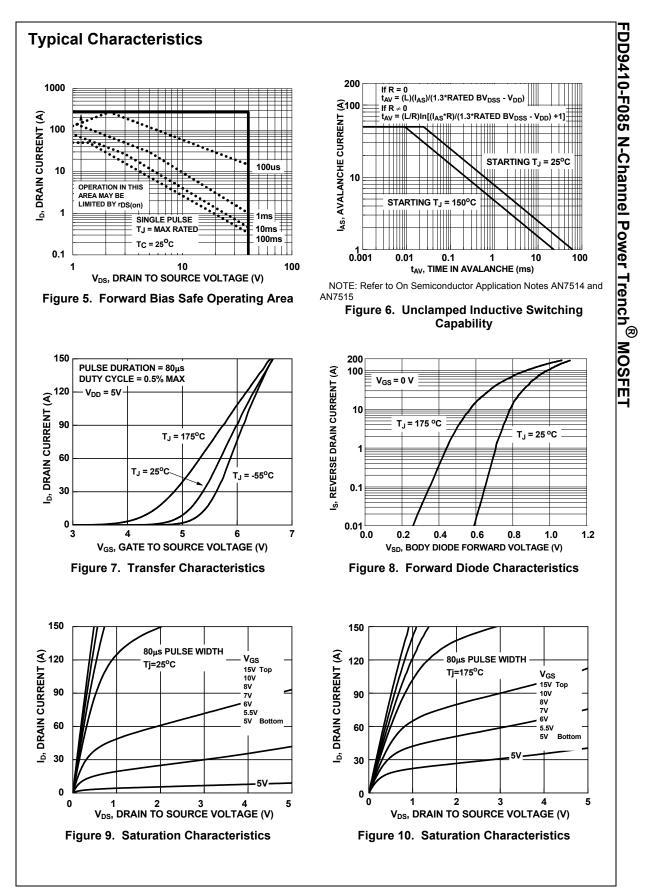
Note:

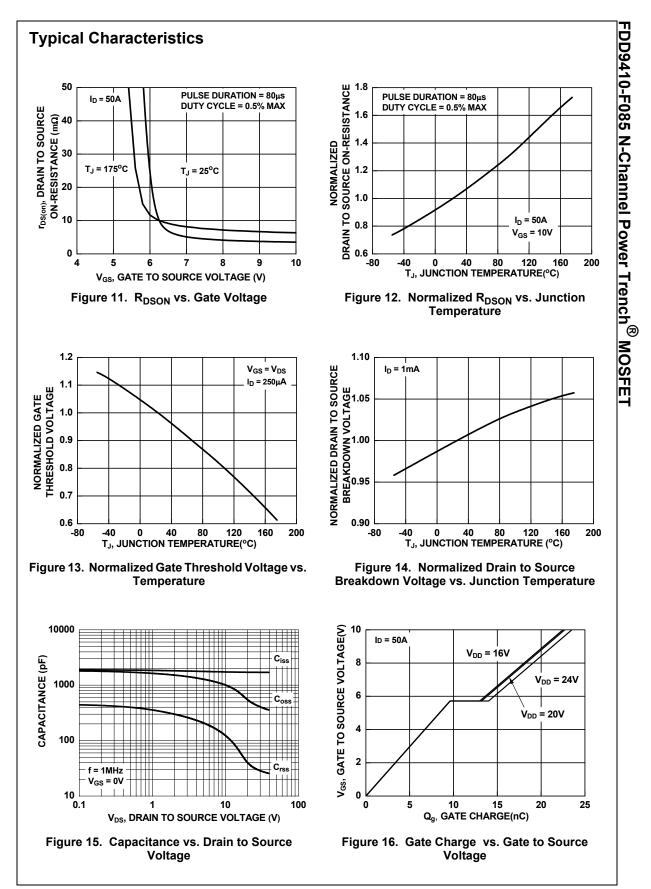
Q<sub>gd</sub>

4: The maximum value is specified by design at  $T_J$  = 175°C. Product is not tested to this condition in production.



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